

BGF148E6327XTSA1 Information


For Reference Only

Part Number [BGF148E6327XTSA1](#)
Manufacturer Infineon Technologies
Category Integrated Circuits (ICs)
[Specialized ICs](#)
Description IC INTERFACE PROTECTION TSNP14-2
Package 14-XFQFN Exposed Pad
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


BGF148E6327XTSA1 Specifications

Manufacturer Part Number	BGF148E6327XTSA1
Manufacturer	Infineon Technologies
Category	Integrated Circuits (ICs) Specialized ICs
Package	14-XFQFN Exposed Pad
Series	-
Type	Interface Protection
Applications	HSMMC ESD Protection, EMI Filter
Mounting Type	Surface Mount
Package / Case	14-XFQFN Exposed Pad
Supplier Device Package	PG-TSNP-14-2
	Report errors?

BGF148E6327XTSA1 Guarantees

Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.


Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

BGF148E6327XTSA1 Payment Methods



BGF148E6327XTSA1 Shipping Methods



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